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APPLICANTS

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**** CONTINUING DATA *******

This application is a CON of 09/920,713 08/03/2001 PAT 6,713,319 *of the*
 which is a DIV of 09/580,624 05/30/2000 PAT 6,281,111 *of the*
 which is a DIV of 08/959,667 10/29/1997 PAT 6,097,091 *of the*

**** FOREIGN APPLICATIONS *******JAPAN H09-128176 05/19/1997 *of the*

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

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Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no	STATE OR	SHEETS	TOTAL	INDEPENDENT
35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after allowance <i>Met after</i>	COUNTRY	DRAWING	CLAIMS	CLAIMS
Verified and Acknowledged <i>Examiner's Signature</i> <i>Initials</i>	JAPAN	16	9	2

ADDRESS

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TITLE

Method for fabricating a semiconductor apparatus including a sealing member with reduced thermal stress

FILING FEE RECEIVED 770	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other
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